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Texas Instruments
TL1431QLPR

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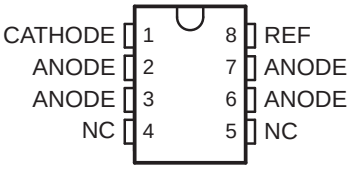
PRECISION PROGRAMMABLE REFERENCE

Check for Samples: TL1431

FEATURES

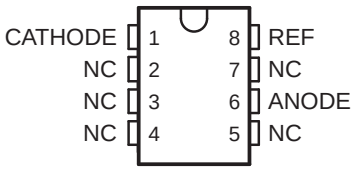
- **0.4% Initial Voltage Tolerance**
- **0.2-Ω Typical Output Impedance**
- **Fast Turnon…500 ns**
- **Sink Current Capability…1 mA to 100 mA**
- **Low Reference Current (REF)**
- **Adjustable Output Voltage…$V_{I(ref)}$ to 36 V**

D PACKAGE
(TOP VIEW)



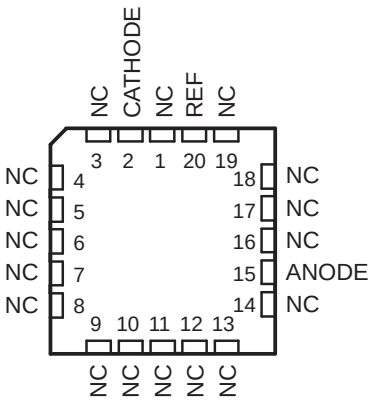
NC – No internal connection
ANODE terminals are connected internally

JG OR PW PACKAGE
(TOP VIEW)



NC – No internal connection

FK PACKAGE
(TOP VIEW)



KTP PACKAGE
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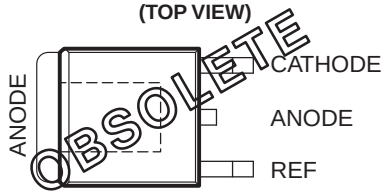
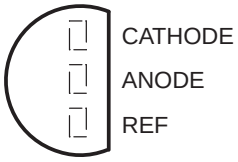


LP PACKAGE
(TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The TL1431 is a precision programmable reference with specified thermal stability over automotive, commercial, and military temperature ranges. The output voltage can be set to any value between $V_{I(ref)}$ (approximately 2.5 V) and 36 V with two external resistors (see Figure 16). This device has a typical output impedance of 0.2 Ω. Active output circuitry provides a very sharp turnon characteristic, making the device an excellent replacement for Zener diodes and other types of references in applications such as onboard regulation, adjustable power supplies, and switching power supplies.

The TL1431C is characterized for operation over the commercial temperature range of 0°C to 70°C. The TL1431Q is characterized for operation over the full automotive temperature range of –40°C to 125°C. The TL1431M is characterized for operation over the full military temperature range of –55°C to 125°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerFLEX is a trademark of Texas Instruments.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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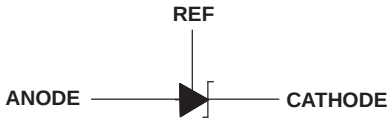
ORDERING INFORMATION(1)

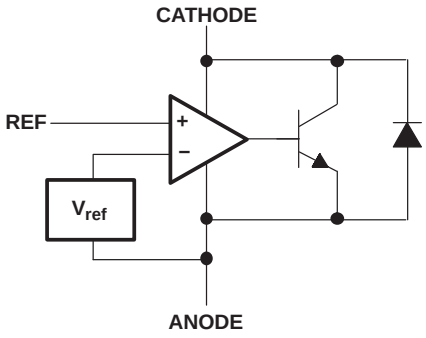
T_A	PACKAGE(2)		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PowerFLEX™ – KTP	Reel of 3000	TL1431CKTPR	OBSOLETE
	SOIC – D	Tube of 75	TL1431CD	1431C
		Reel of 2500	TL1431CDR	
	TO-226 / TO-92 – LP	Bulk of 1000	TL1431CLP	TL1431C
		Reel of 2000	TL1431CLPR	
		Ammo of 2000	TL1431CLPME3	
	TSSOP – PW	Tube of 150	TL1431CPW	T1431
		Reel of 2000	TL1431CPWR	
–40°C to 125°C	SOIC – D	Tube of 75	TL1431QD	TL1431QD
		Reel of 2500	TL1431QDR	
	TSSOP – PW	Tube of 150	TL1431QPW	T1431QPW
		Reel of 2000	TL1431QPWR	
–55°C to 125°C	CDIP – JG	Tube of 50	TL1431MJG	TL1431MJG
	LCCC – FK	Tube of 55	TL1431MFK	TL1431MFK

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

SYMBOL



FUNCTIONAL BLOCK DIAGRAM



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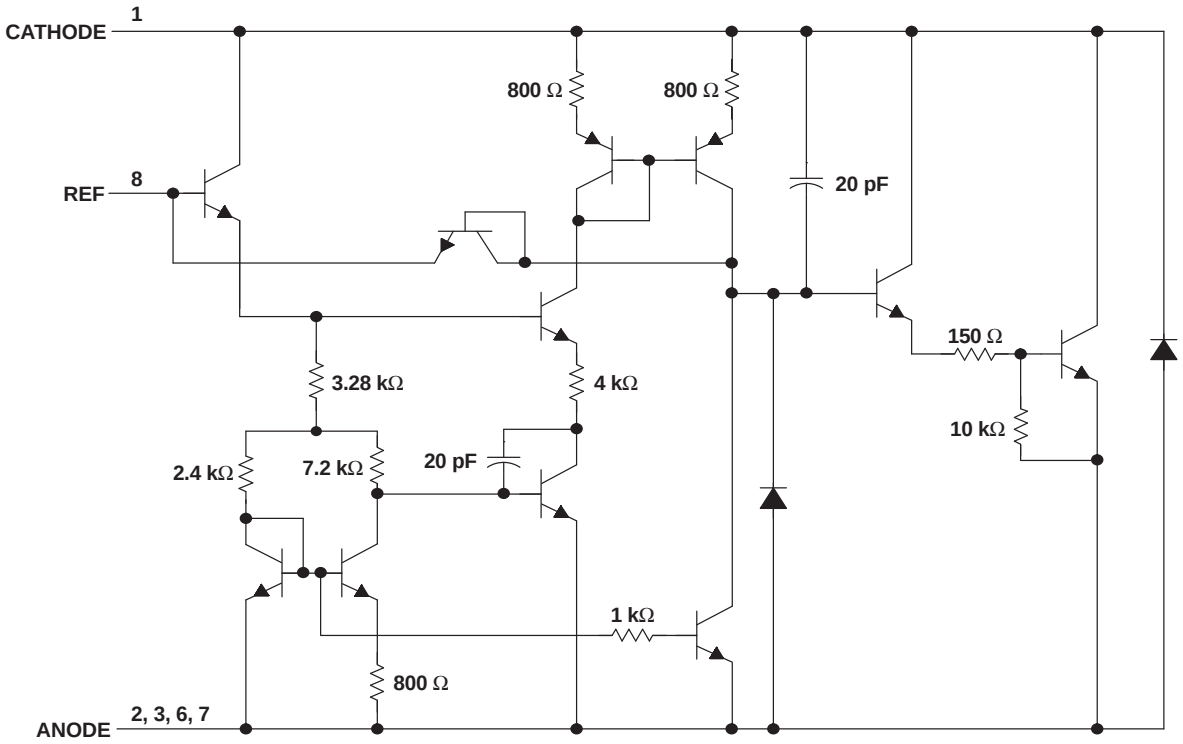
EQUIVALENT SCHEMATIC



A. All component values are nominal.
B. Pin numbers shown are for the D package.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{KA}	Cathode voltage(2)			37	V
I_{KA}	Continuous cathode current range		–100	150	mA
$I_{I(ref)}$	Reference input current range		–0.05	10	mA
θ_{JA}	Package thermal impedance(3) (4)	D package		97	°C/W
		LP package		140	
		PW package		149	
θ_{JC}	Package thermal impedance(5) (6)	FK package		5.61	°C/W
		JG package		14.5	
T_J	Operating virtual junction temperature			150	°C
	Lead temperature	1,6 mm (1/16 in) from case for 10 s		260	°C
T_{stg}	Storage temperature range		–65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltage values are with respect to ANODE, unless otherwise noted.
(3) Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} – T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(4) The package thermal impedance is calculated in accordance with JESD 51-7.
(5) Maximum power dissipation is a function of $T_{J(max)}$, θ_{JC}, and T_C. The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_{J(max)} – T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(6) The package thermal impedance is calculated in accordance with MIL-STD-883.

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Recommended Operating Conditions

			MIN	MAX	UNIT
V_{KA}	Cathode voltage		$V_{I(ref)}$	36	V
I_{KA}	Cathode current		1	100	mA
T_A	Operating free-air temperature	TL1431C	0	70	°C
		TL1431Q	–40	125	
		TL1431M	–55	125	

Electrical Characteristics

at specified free-air temperature, I_{KA} = 10 mA (unless otherwise noted)

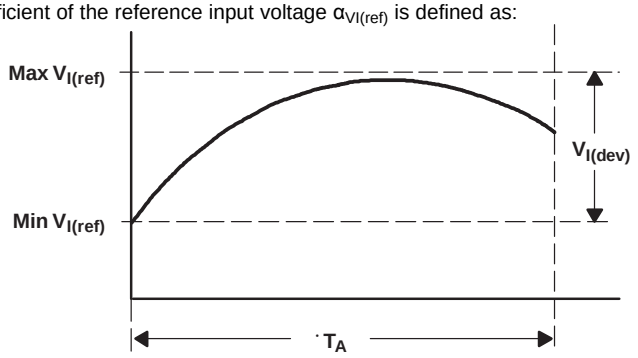
PARAMETER		TEST CONDITIONS	T_A (1)	TEST CIRCUIT	TL1431C			UNIT
					MIN	TYP	MAX	
$V_{I(ref)}$	Reference input voltage	$V_{KA} = V_{I(ref)}$	25°C	Figure 1	2490	2500	2510	mV
			Full range		2480		2520	
$V_{I(dev)}$	Deviation of reference input voltage over full temperature range(2)	$V_{KA} = V_{I(ref)}$	Full range	Figure 1		4	20	mV
$\frac{\Delta V_{I(ref)}}{\Delta V_{KA}}$	Ratio of change in reference input voltage to the change in cathode voltage	ΔV_{KA} = 3 V to 36 V	Full range	Figure 2		–1.1	–2	mV/V
$I_{I(ref)}$	Reference input current	R1 = 10 kΩ, R2 = ∞	25°C	Figure 2		1.5	2.5	μA
			Full range				3	
$I_{I(dev)}$	Deviation of reference input current over full temperature range(2)	R1 = 10 kΩ, R2 = ∞	Full range	Figure 2		0.2	1.2	μA
I_{min}	Minimum cathode current for regulation	$V_{KA} = V_{I(ref)}$	25°C	Figure 1		0.45	1	mA
I_{off}	Off-state cathode current	V_{KA} = 36 V, $V_{I(ref)}$ = 0	25°C	Figure 3		0.18	0.5	μA
			Full range				2	
$\lvert z_{KA} \rvert$	Output impedance(3)	$V_{KA} = V_{I(ref)}$, f ≤ 1 kHz, I_{KA} = 1 mA to 100 mA	25°C	Figure 1		0.2	0.4	Ω

(1) Full range is 0°C to 70°C for C-suffix devices.

(2) The deviation parameters $V_{I(dev)}$ and $I_{I(dev)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage $\alpha_{VI(ref)}$ is defined as:

$$\left|\alpha_{V_{I(ref)}}\right| \left(\frac{ppm}{°C}\right) = \frac{\left(\frac{V_{I(dev)}}{V_{I(ref)\ at\ 25°C}}\right) \times 10^6}{T_A}$$

where:
ΔT_A is the rated operating temperature range of the device.



$\alpha_{VI(ref)}$ is positive or negative, depending on whether minimum $V_{I(ref)}$ or maximum $V_{I(ref)}$, respectively, occurs at the lower temperature.

(3) The output impedance is defined as: $|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{KA}}$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by: $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|z_{KA}|\left(1 + \frac{R1}{R2}\right)$.

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Electrical Characteristics

at specified free-air temperature, I_{KA} = 10 mA (unless otherwise noted)

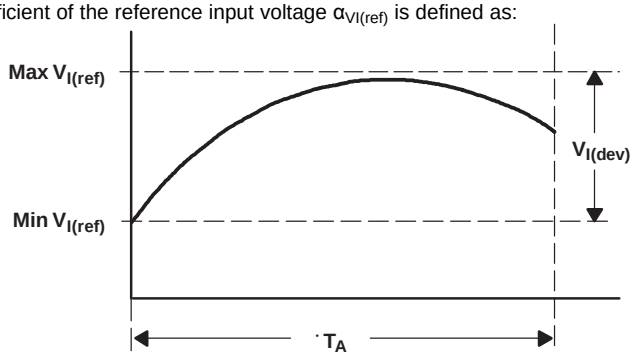
PARAMETER		TEST CONDITIONS	T_A (1)	TEST CIRCUIT	TL1431Q			TL1431M			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
$V_{I(ref)}$	Reference input voltage	$V_{KA} = V_{I(ref)}$	25°C	Figure 1	2490	2500	2510	2475	2500	2540	mV
			Full range		2470		2530	2460		2550	
$V_{I(dev)}$	Deviation of reference input voltage over full temperature range (2)	$V_{KA} = V_{I(ref)}$	Full range	Figure 1		17	55		17	55 (3)	mV
$\frac{\Delta V_{I(ref)}}{\Delta V_{KA}}$	Ratio of change in reference input voltage to the change in cathode voltage	ΔV_{KA} = 3 V to 36 V	Full range	Figure 2		–1.1	–2		–1.1	–2	mV/V
$I_{I(ref)}$	Reference input current	R1 = 10 kΩ, R2 = ∞	25°C	Figure 2		1.5	2.5		1.5	2.5	μA
			Full range				4			5	
$I_{I(dev)}$	Deviation of reference input current over full temperature range (2)	R1 = 10 kΩ, R2 = ∞	Full range	Figure 2		0.5	2		0.5	3 (3)	μA
I_{min}	Minimum cathode current for regulation	$V_{KA} = V_{I(ref)}$	25°C	Figure 1		0.45	1		0.45	1	mA
I_{off}	Off-state cathode current	V_{KA} = 36 V, $V_{I(ref)}$ = 0	25°C	Figure 3		0.18	0.5		0.18	0.5	μA
			Full range				2			2	
$\lvert z_{KA} \rvert$	Output impedance (4)	$V_{KA} = V_{I(ref)}$, f ≤ 1 kHz, I_{KA} = 1 mA to 100 mA	25°C	Figure 1		0.2	0.4		0.2	0.4	Ω

(1) Full range is –40°C to 125°C for Q-suffix devices and –55°C to 125°C for M-suffix devices.

(2) The deviation parameters $V_{I(dev)}$ and $I_{I(dev)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage $\alpha_{VI(ref)}$ is defined as:

$$\left|\alpha_{VI(ref)}\right| \left(\frac{ppm}{°C}\right) = \frac{\left(\frac{V_{I(dev)}}{V_{I(ref)\ at\ 25°C}}\right) \times 10^6}{T_A}$$

where:
ΔT_A is the rated operating temperature range of the device.



$\alpha_{VI(ref)}$ is positive or negative, depending on whether minimum $V_{I(ref)}$ or maximum $V_{I(ref)}$, respectively, occurs at the lower temperature.

(3) On products compliant to MIL-PRF-38535, this parameter is not production tested.

(4) The output impedance is defined as: $|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{KA}}$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by: $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|z_{KA}|\left(1 + \frac{R1}{R2}\right)$.

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PARAMETER MEASUREMENT INFORMATION

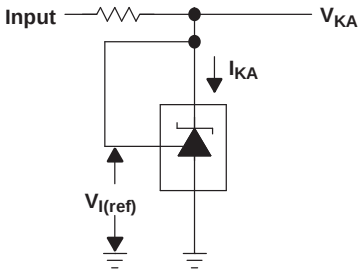

Figure 1. Test Circuit for $V_{(KA)} = V_{ref}$

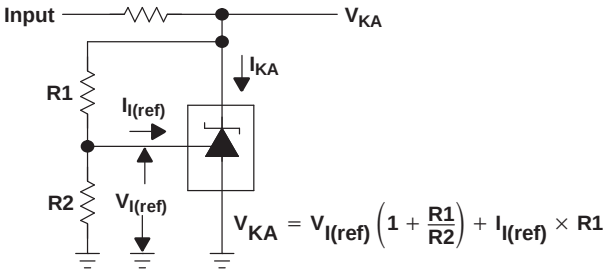

Figure 2. Test Circuit for $V_{(KA)} > V_{ref}$

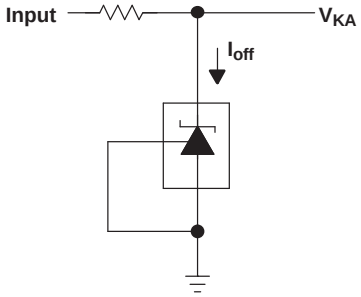

Figure 3. Test Circuit for I_{off}

TYPICAL CHARACTERISTICS

Data at high and low temperatures are applicable only within the recommended operating free-air temperature ranges of the various devices.

Table of Graphs

GRAPH	FIGURE
Reference voltage vs Free-air temperature	Figure 4
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Equivalent input-noise voltage vs Frequency	Figure 10
Equivalent input-noise voltage over a 10-second period	Figure 11
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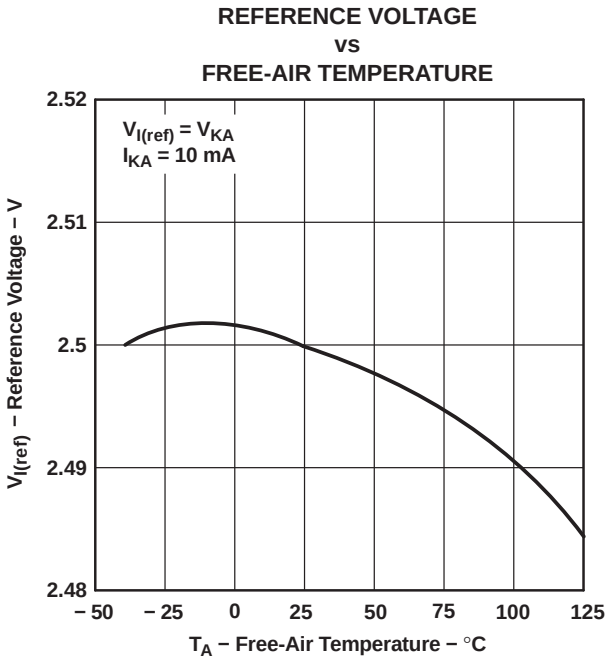

Figure 4.

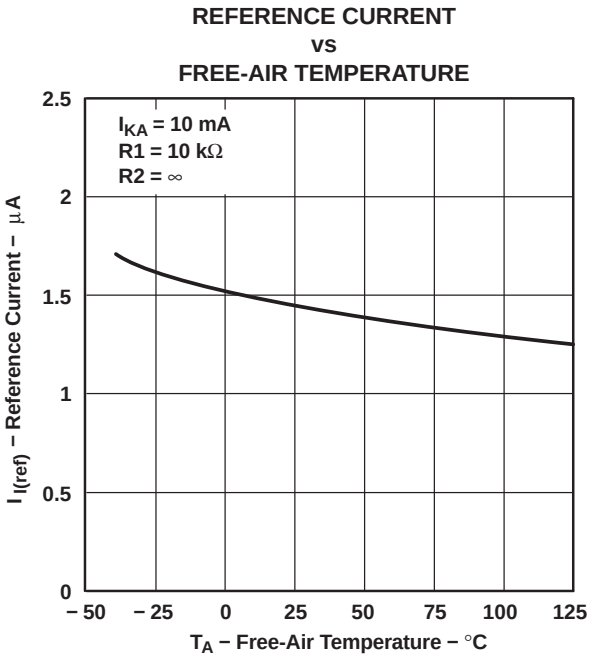

Figure 5.

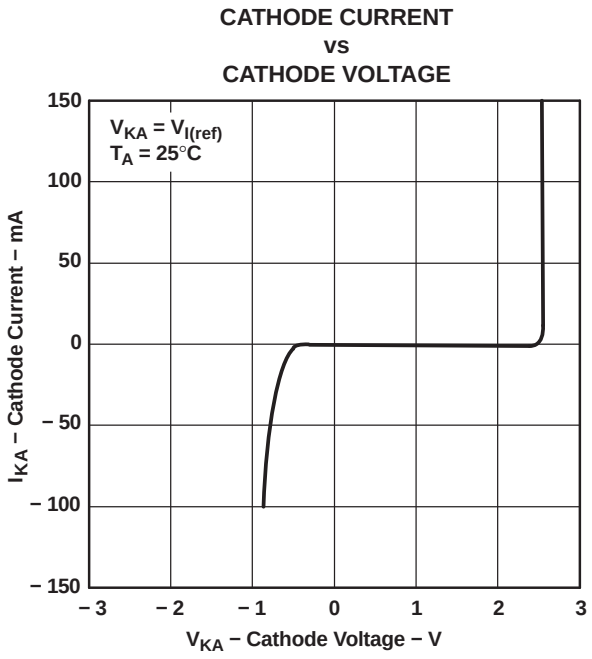

Figure 6.

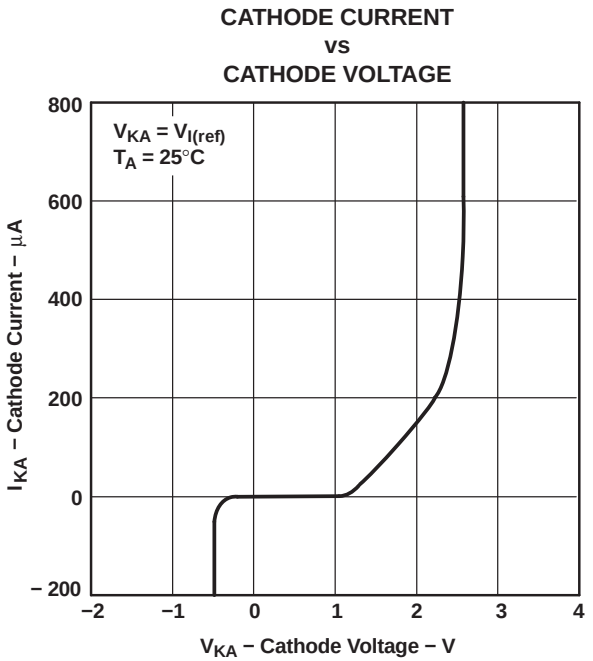

Figure 7.

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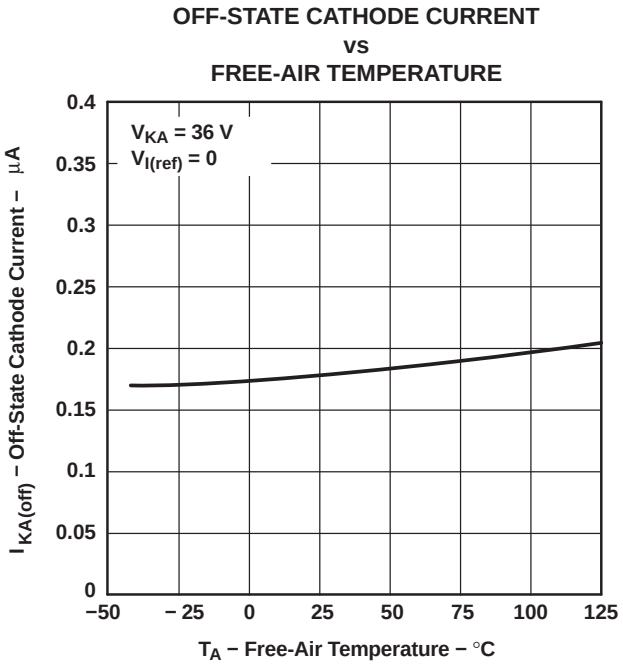

Figure 8.

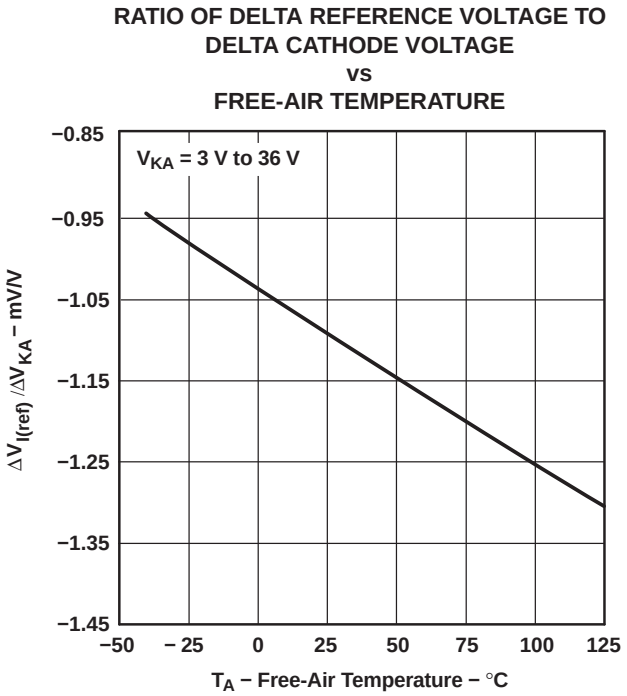

Figure 9.

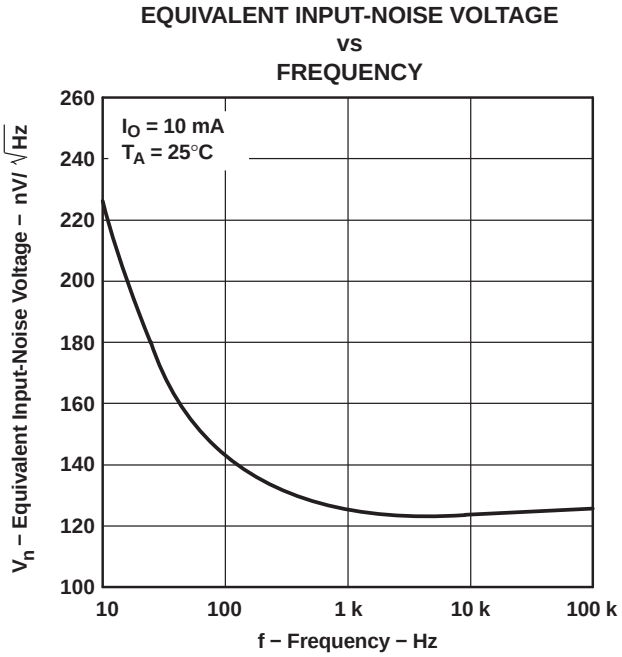

Figure 10.

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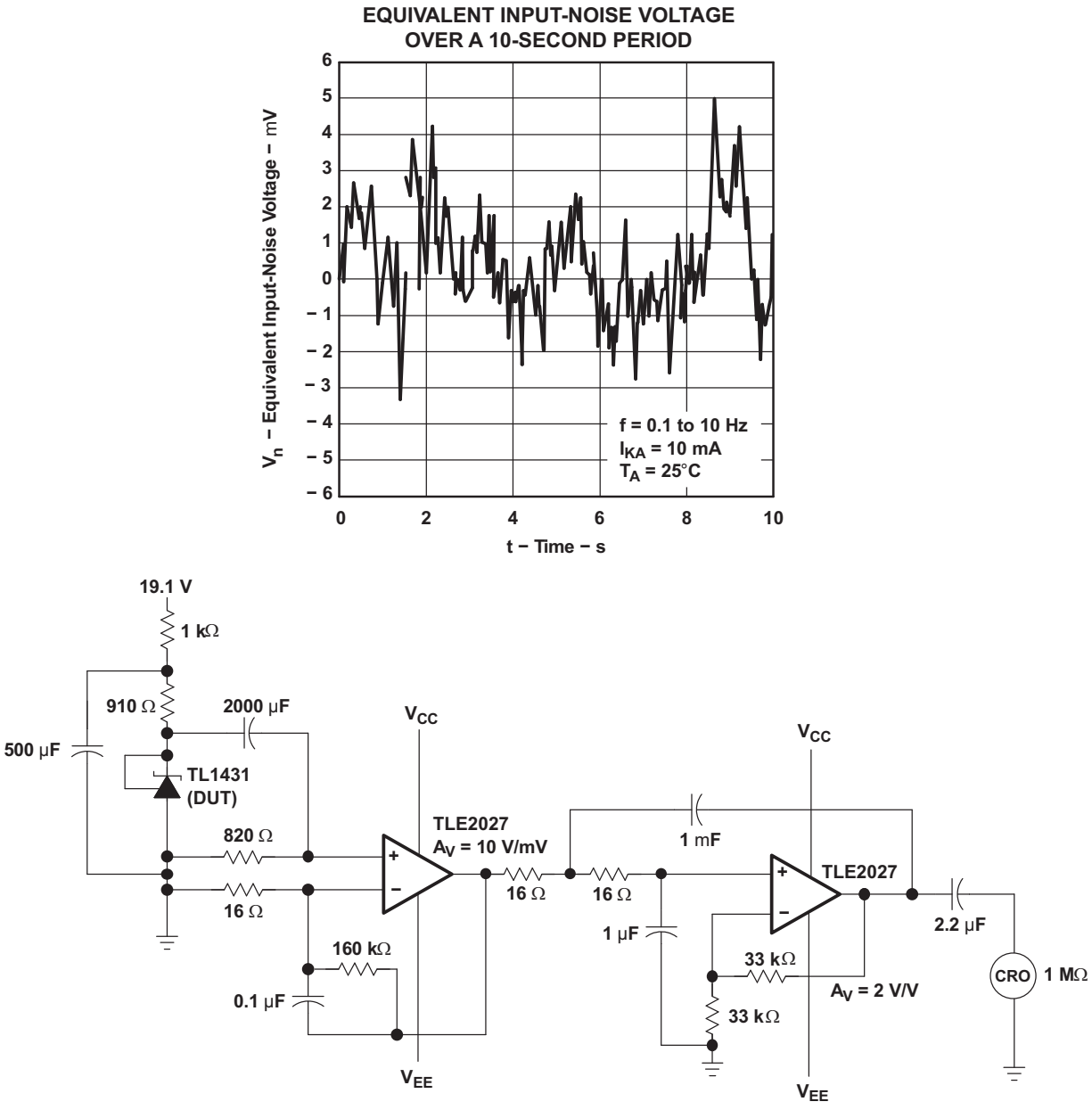

TEST CIRCUIT FOR 0.1-Hz TO 10-Hz EQUIVALENT INPUT-NOISE VOLTAGE

Figure 11.

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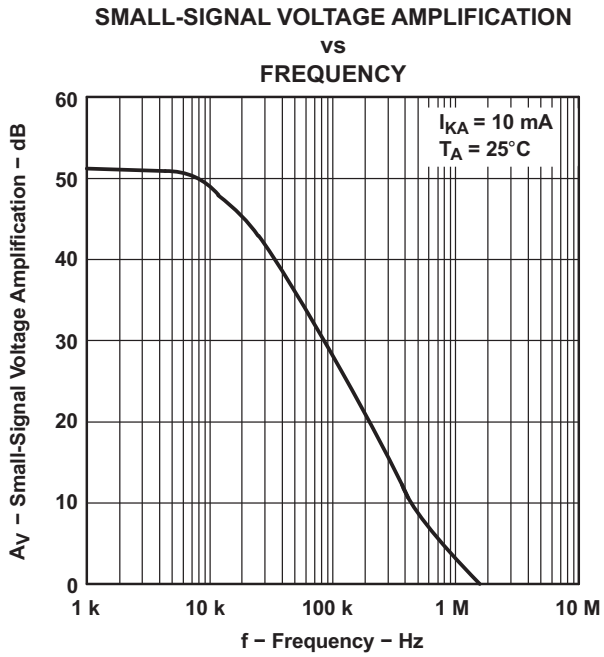
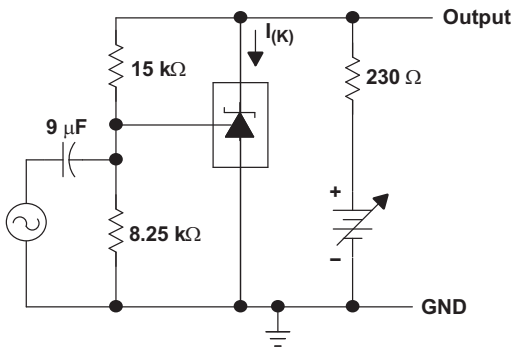
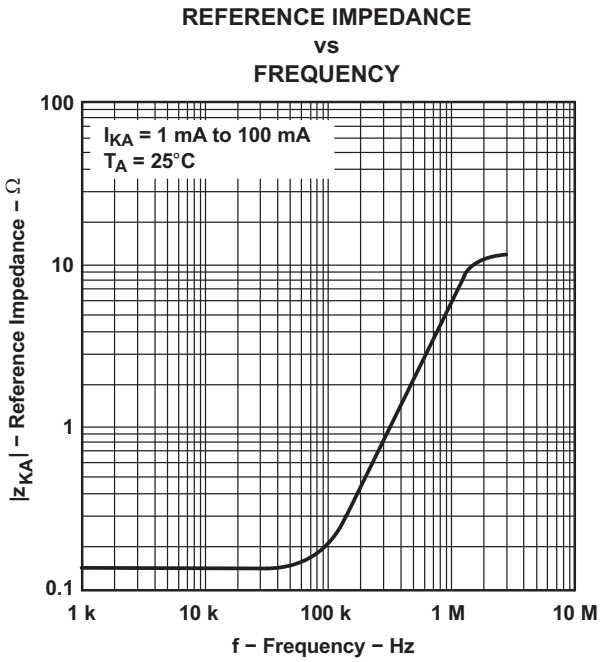
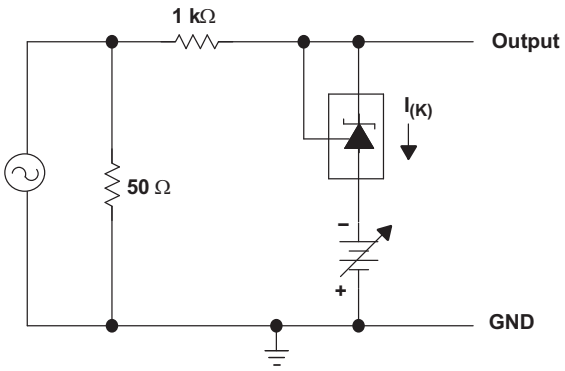




TEST CIRCUIT FOR VOLTAGE AMPLIFICATION

Figure 12.





TEST CIRCUIT FOR REFERENCE IMPEDANCE

Figure 13.

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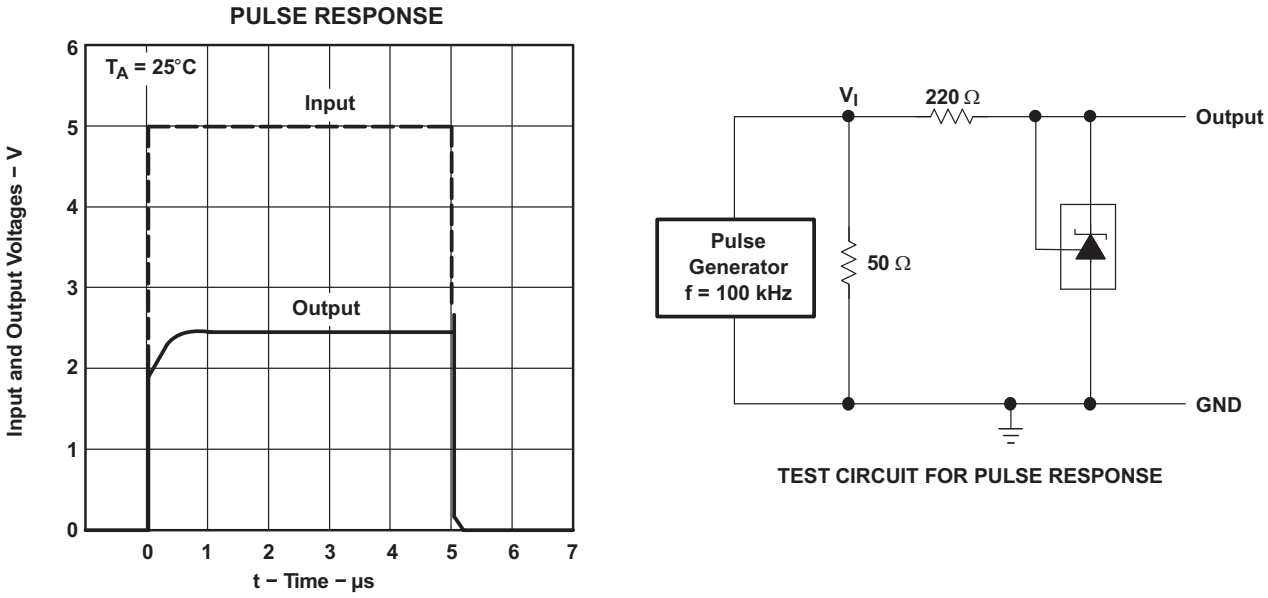
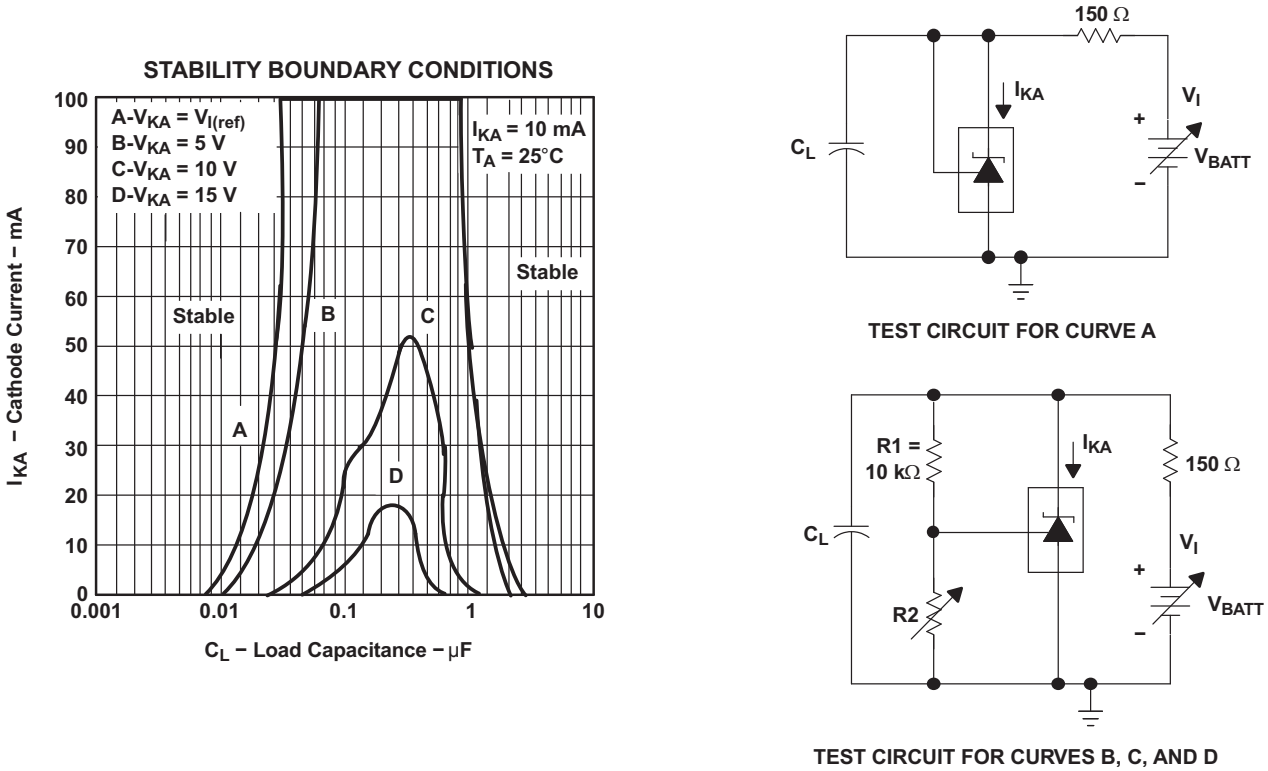


Figure 14.



A. The areas under the curves represent conditions that may cause the device to oscillate. For curves B, C, and D, R2, and V+ are adjusted to establish the initial V_{KA} and I_{KA} conditions, with C_L = 0. V_{BATT} and C_L then are adjusted to determine the ranges of stability.

Figure 15.

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APPLICATION INFORMATION

Table 1. Table of Application Circuits

APPLICATION	FIGURE
Shunt regulator	Figure 16
Single-supply comparator with temperature-compensated threshold	Figure 17
Precision high-current series regulator	Figure 18
Output control of a three-terminal fixed regulator	Figure 19
Higher-current shunt regulator	Figure 20
Crowbar	Figure 21
Precision 5-V, 1.5-A, 0.5% regulator	Figure 22
5-V precision regulator	Figure 23
PWM converter with 0.5% reference	Figure 24
Voltage monitor	Figure 25
Delay timer	Figure 26
Precision current limiter	Figure 27
Precision constant-current sink	Figure 28

A. R should provide cathode current ≥1 mA to the TL1431 at minimum $V_{(BATT)}$.

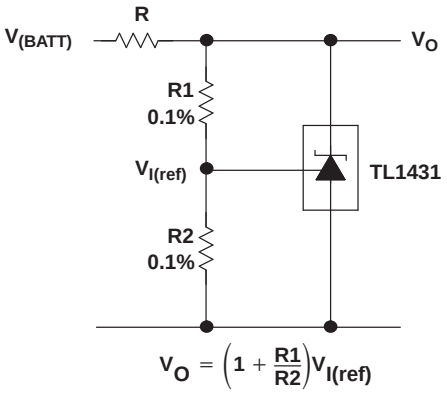

Figure 16. Shunt Regulator

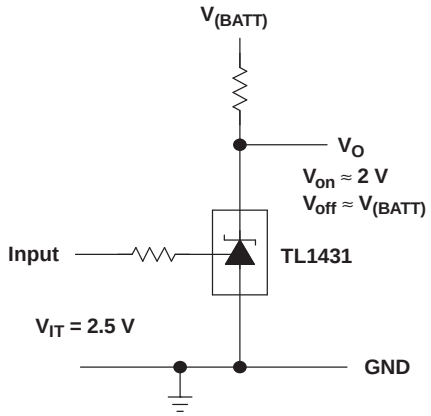

Figure 17. Single-Supply Comparator With Temperature-Compensated Threshold

A. R should provide cathode current ≥1 mA to the TL1431 at minimum $V_{(BATT)}$.

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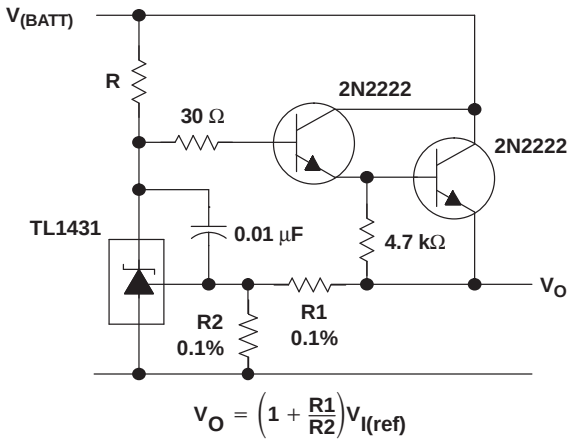

Figure 18. Precision High-Current Series Regulator

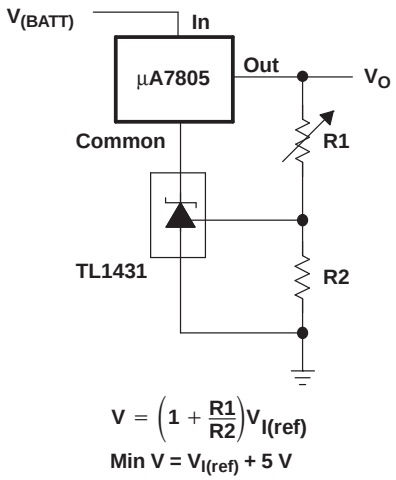

Figure 19. Output Control of a Three-Terminal Fixed Regulator

A. Refer to the stability boundary conditions in Figure 15 to determine allowable values for C.

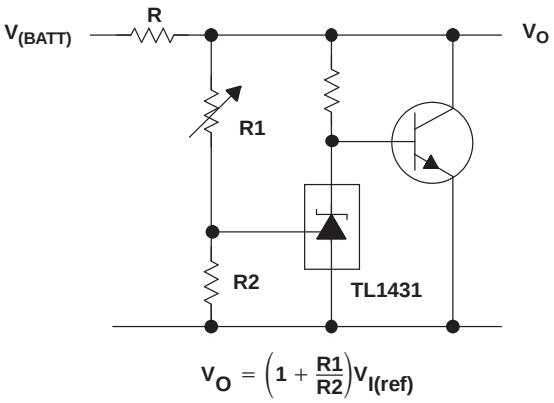

Figure 20. Higher-Current Shunt Regulator

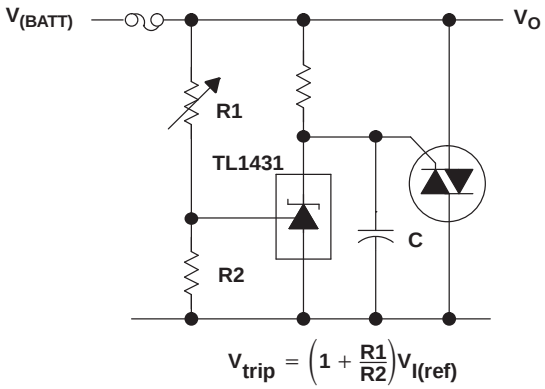

Figure 21. Crowbar

A. R_b should provide cathode current ≥1 mA to the TL1431.

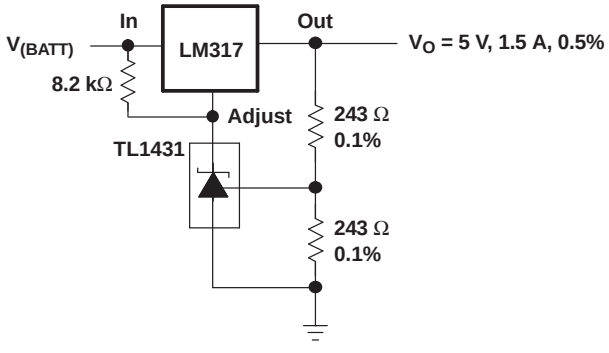

Figure 22. Precision 5-V, 1.5-A, 0.5% Regulator

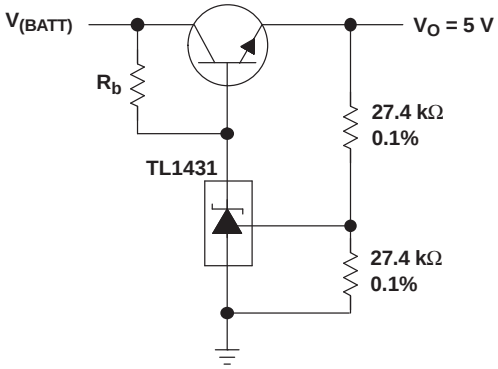

Figure 23. 5-V Precision Regulator

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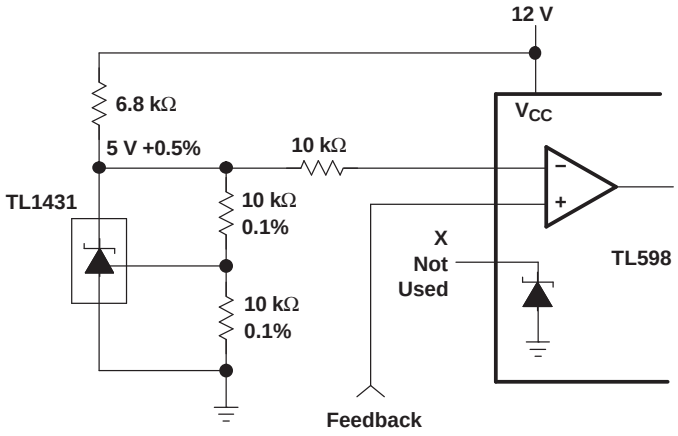


Figure 24. PWM Converter With 0.5% Reference

A. Select R3 and R4 to provide the desired LED intensity and cathode current ≥1 mA to the TL1431.

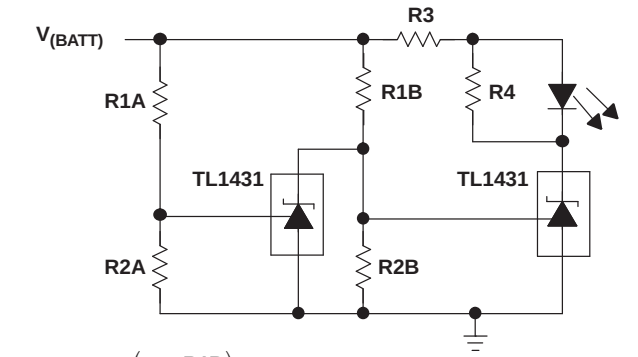


Figure 25. Voltage Monitor

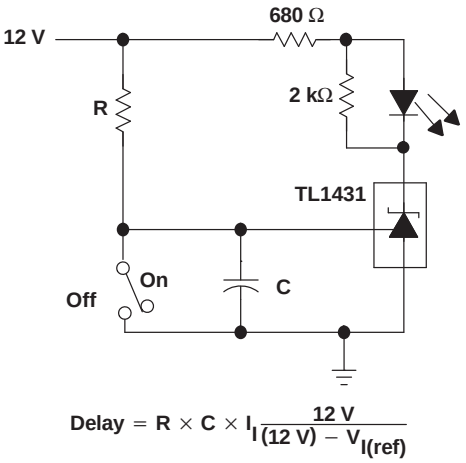
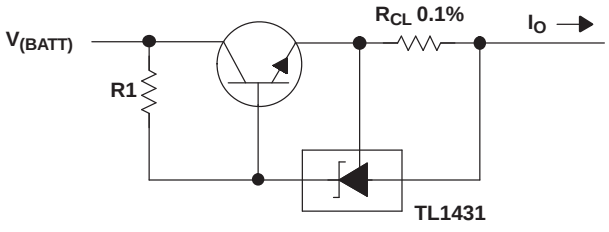


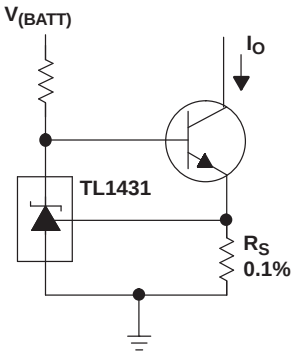
Figure 26. Delay Timer



$$I_O = \frac{V_{I(ref)}}{R_{CL}} + I_{KA}$$

$$R1 = \frac{V_{(BATT)}}{\left(\frac{I_O}{h_{FE}}\right) + I_{KA}}$$

Figure 27. Precision Current Limiter



$$I_O = \frac{V_{I(ref)}}{R_S}$$

Figure 28. Precision Constant-Current Sink

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REVISION HISTORY

Changes from Revision October 2007 (N) to Revision M	Page
• Added Ammo option to the LP package in the ORDERING INFORMATION table.	2

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9962001Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-9962001Q2A TL1431MFKB	Samples
5962-9962001QPA	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9962001QPA TL1431M	Samples
TL1431CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	1431C	Samples
TL1431CKTPR	OBSOLETE	PFM	KTP	2		TBD	Call TI	Call TI	0 to 70		
TL1431CLP	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type	0 to 70	TL1431C	Samples
TL1431CLPE3	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type	0 to 70	TL1431C	Samples
TL1431CLPM	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI	0 to 70		
TL1431CLPME3	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type	0 to 70	TL1431C	Samples
TL1431CLPR	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type	0 to 70	TL1431C	Samples
TL1431CLPRE3	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type	0 to 70	TL1431C	Samples
TL1431CPW	ACTIVE	TSSOP	PW	8		TBD	Call TI	Call TI	0 to 70	T1431	Samples
TL1431CPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU | CU SN	Level-1-260C-UNLIM	0 to 70	T1431	Samples

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL1431CPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	T1431	Samples
TL1431MFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	TL1431MFK	Samples
TL1431MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-9962001Q2A TL1431MFKB	Samples
TL1431MJG	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	TL1431MJG	Samples
TL1431MJGB	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	-55 to 125	9962001QPA TL1431M	Samples
TL1431QD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q	Samples
TL1431QDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q	Samples
TL1431QDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q	Samples
TL1431QDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q	Samples
TL1431QLP	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI	-40 to 125		
TL1431QLPR	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI	-40 to 125		
TL1431QPWR	OBSOLETE	TSSOP	PW	8		TBD	Call TI	Call TI	-40 to 125		
TL1431QPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TL1431, TL1431M :

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- Automotive: TL1431-Q1, TL1431-Q1
- Enhanced Product: TL1431-EP, TL1431-EP
- Military: TL1431M
- Space: TL1431-SP, TL1431-SP

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

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- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

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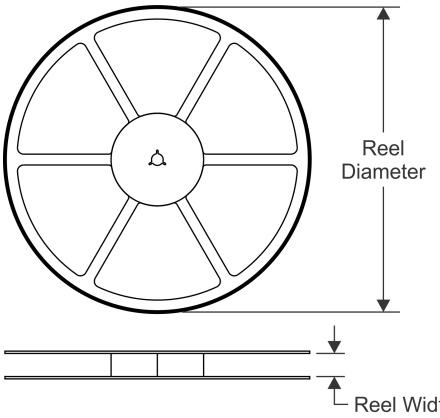
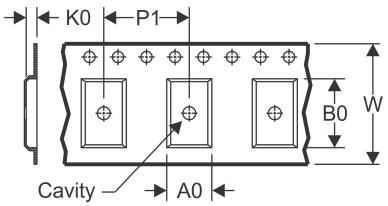
PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

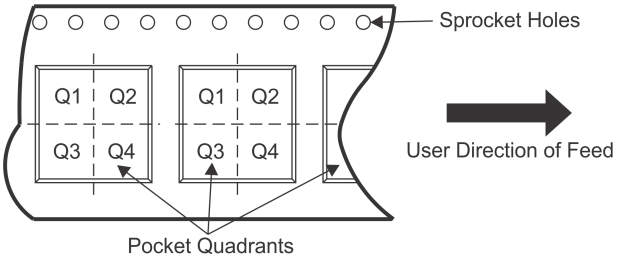


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL1431CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL1431CPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TL1431CPWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TL1431QDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL1431QPWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1

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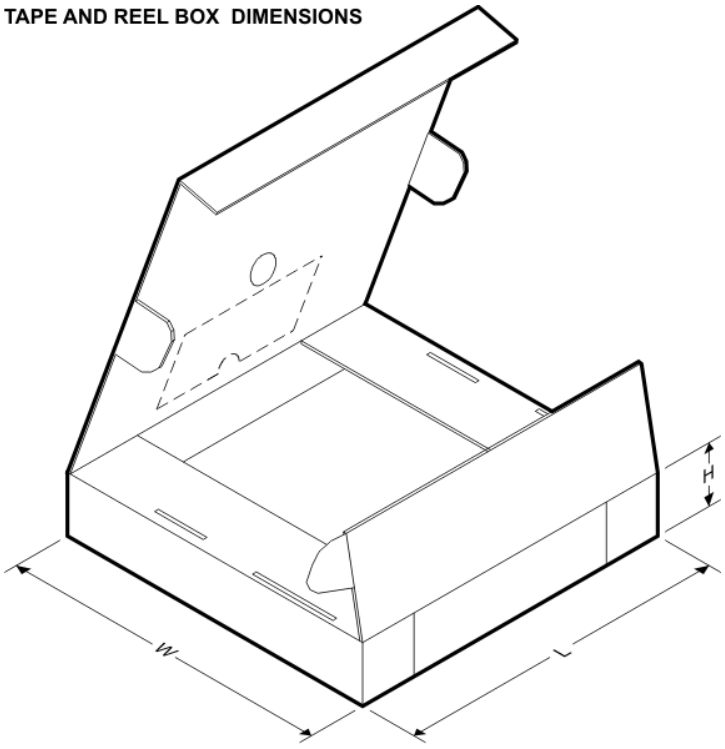
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL1431CDR	SOIC	D	8	2500	340.5	338.1	20.6
TL1431CPWR	TSSOP	PW	8	2000	367.0	367.0	35.0
TL1431CPWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0
TL1431QDR	SOIC	D	8	2500	340.5	338.1	20.6
TL1431QPWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0

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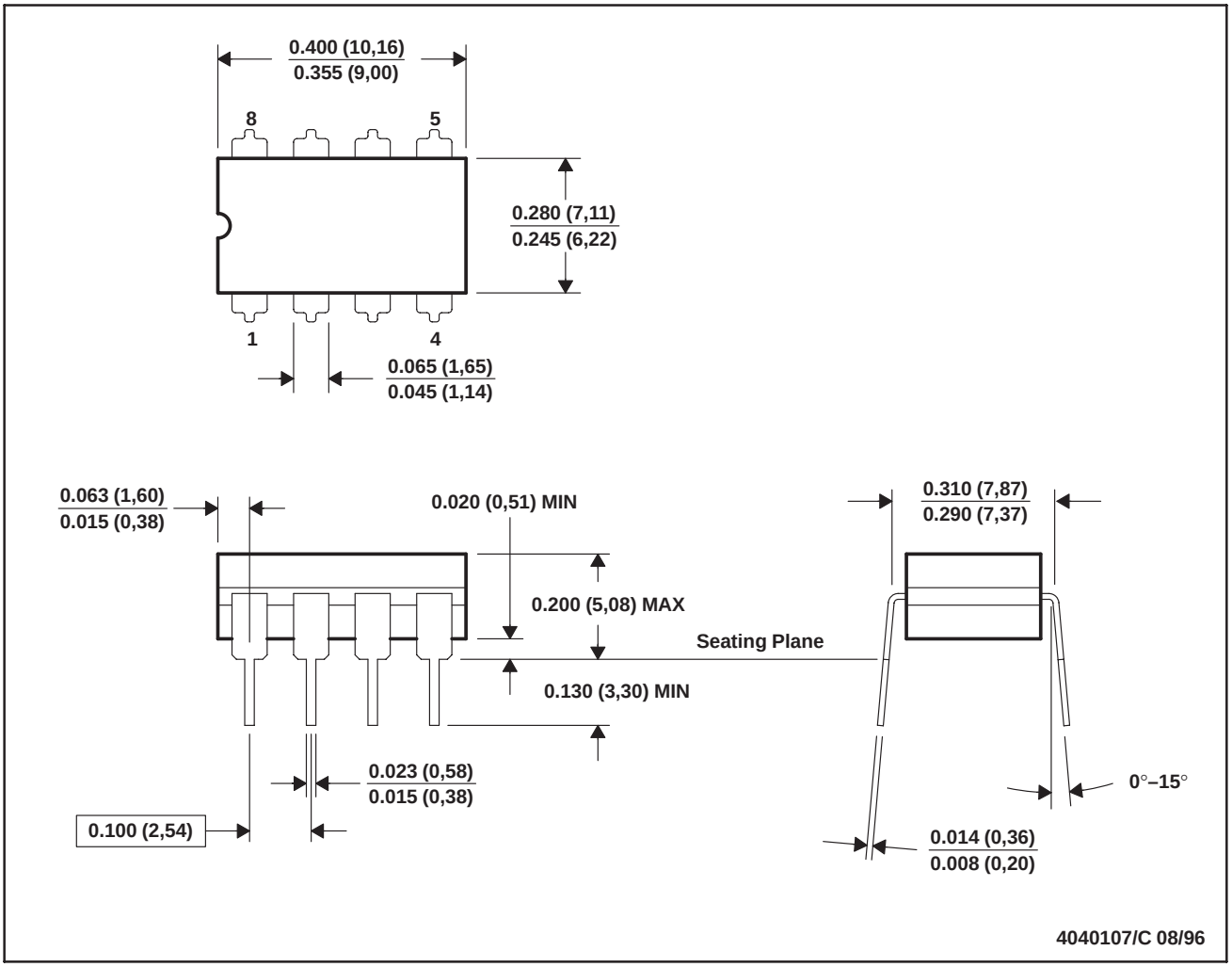
MCER001A – JANUARY 1995 – REVISED JANUARY 1997

JG (R-GDIP-T8) **CERAMIC DUAL-IN-LINE**



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification.
E. Falls within MIL STD 1835 GDIP1-T8

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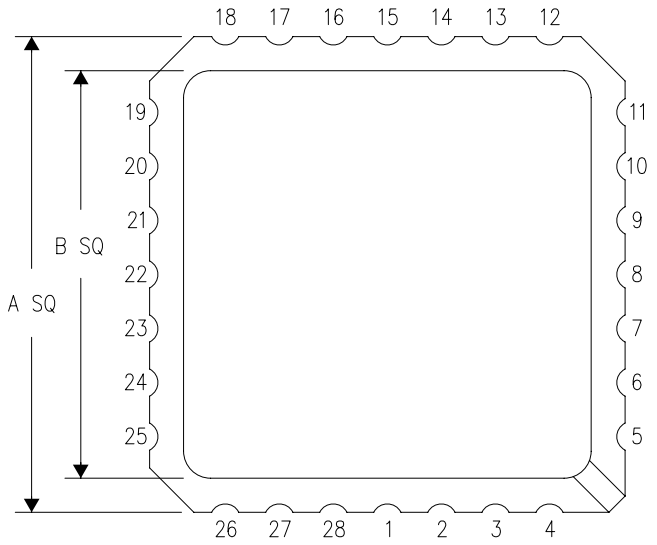
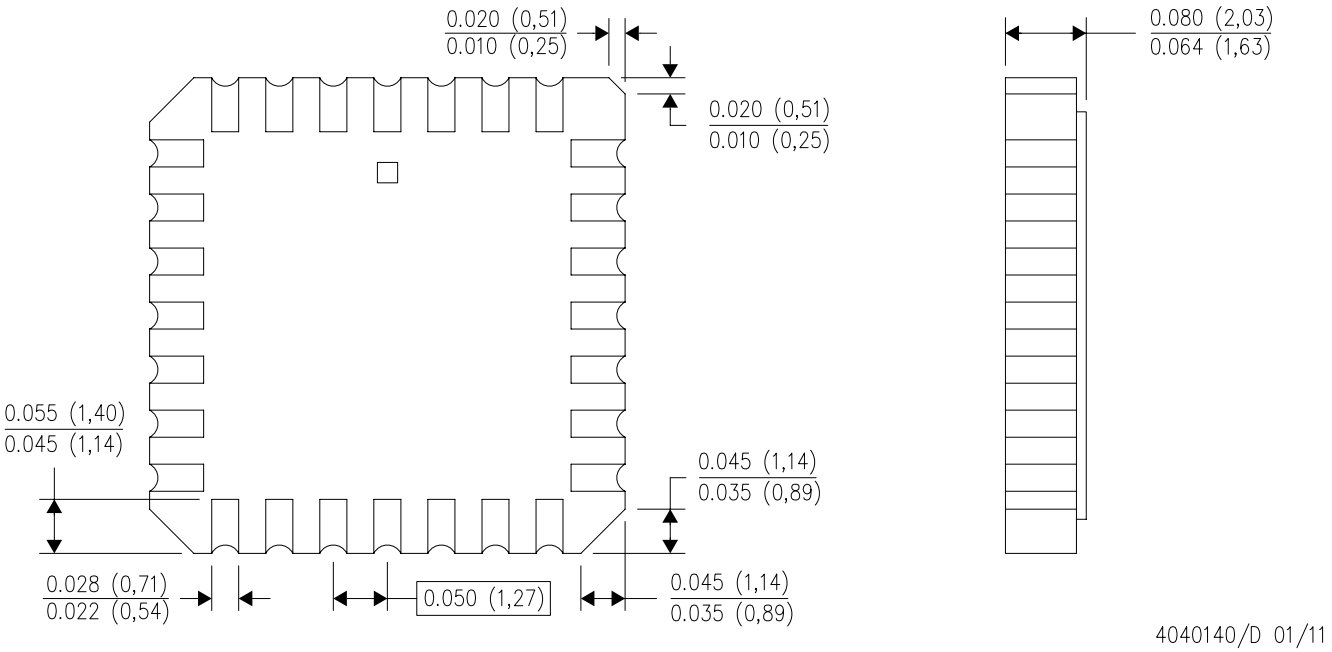
FK (S–CQCC–N**) LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



4040140/D 01/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. Falls within JEDEC MS–004

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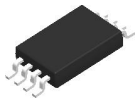
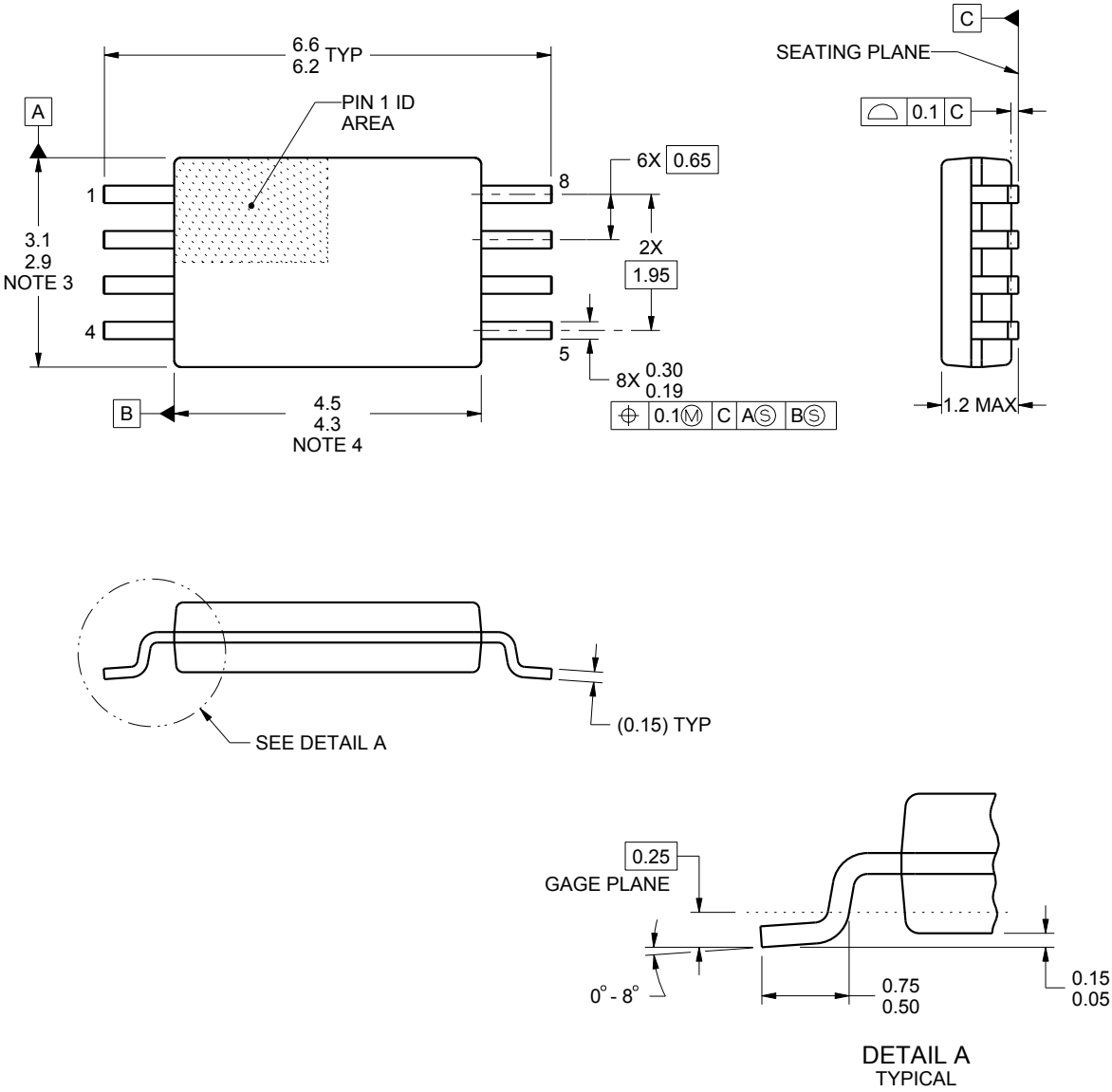
PACKAGE OUTLINE

PW0008A



TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153, variation AA.

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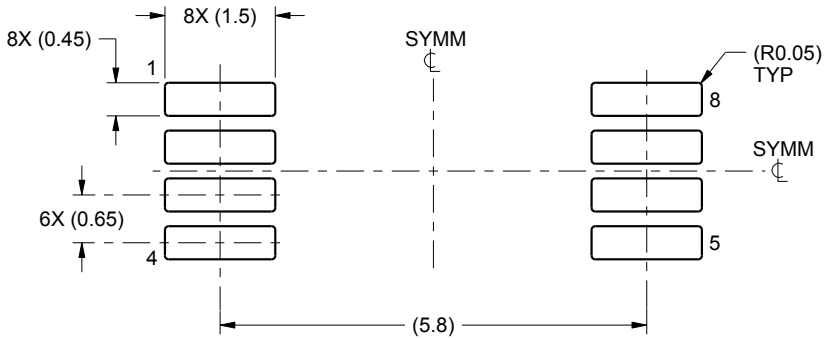
EXAMPLE BOARD LAYOUT

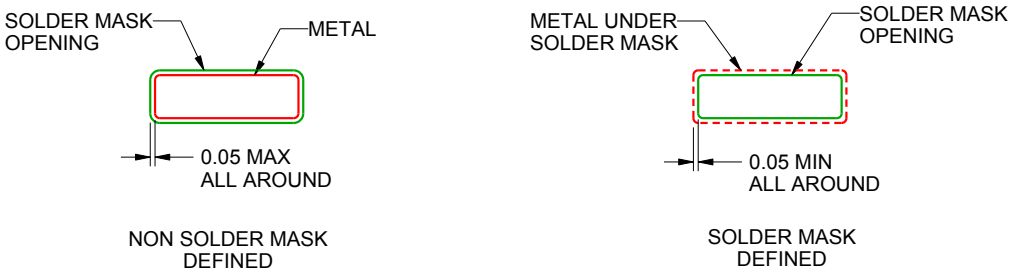
PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:10X



SOLDER MASK DETAILS
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

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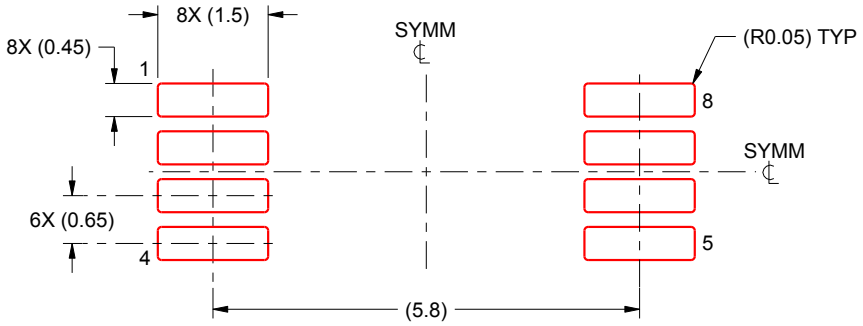
EXAMPLE STENCIL DESIGN

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:10X

4221848/A 02/2015

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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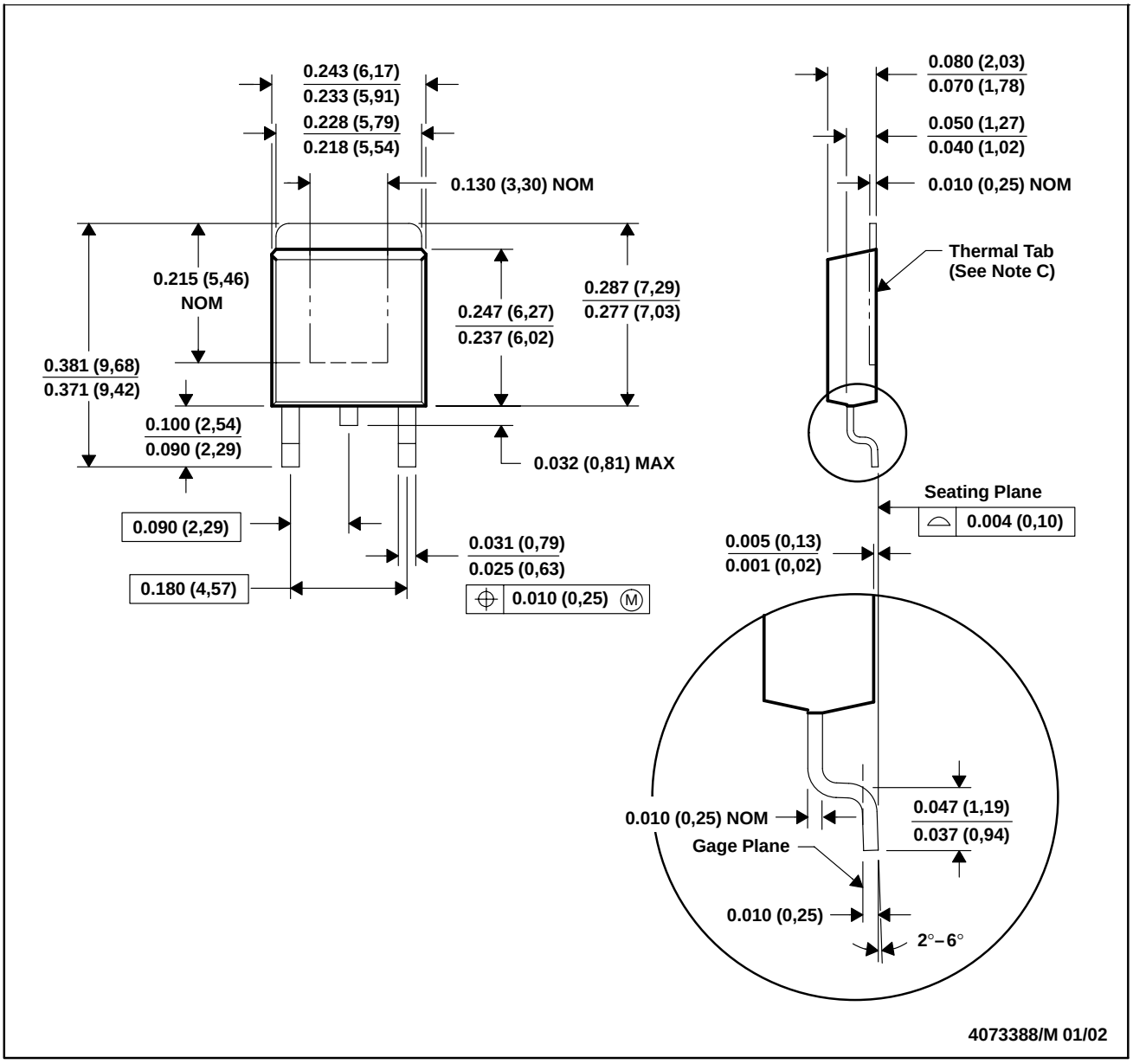
MPSF001F – JANUARY 1996 – REVISED JANUARY 2002

KTP (R-PSFM-G2)

PowerFLEX™ PLASTIC FLANGE-MOUNT PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. The center lead is in electrical contact with the thermal tab.
D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
E. Falls within JEDEC TO-252 variation AC.

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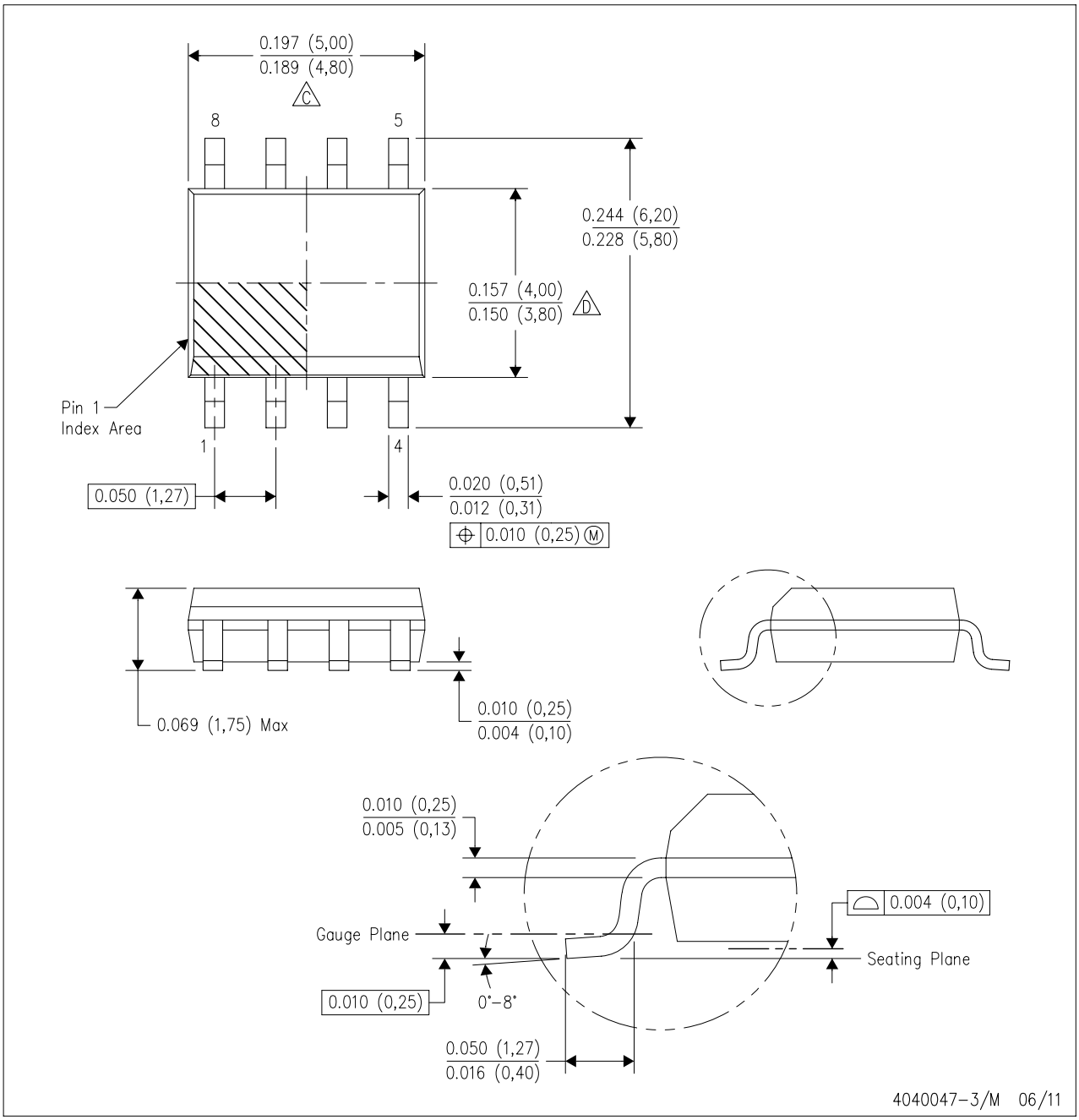
MECHANICAL DATA

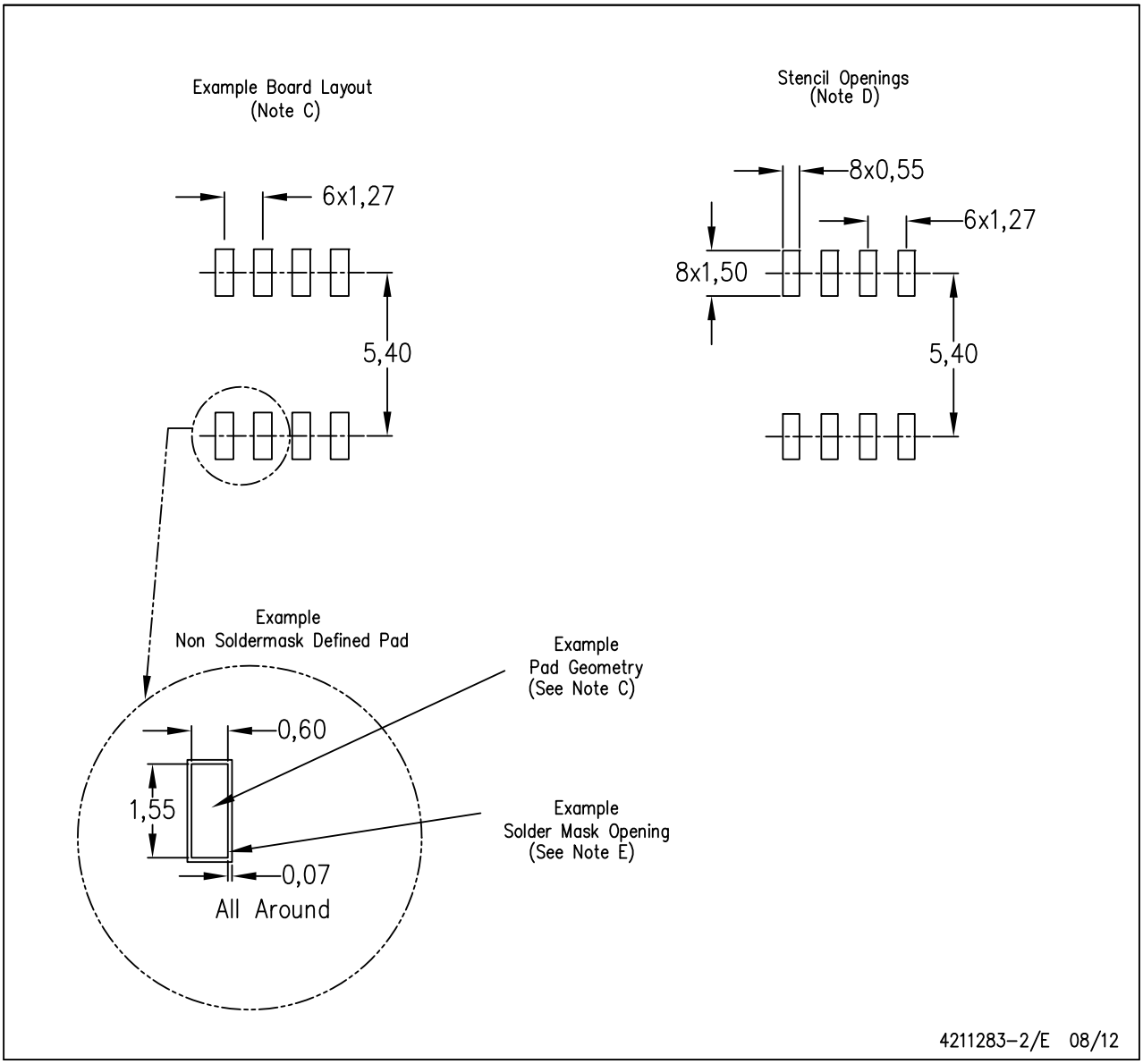
D (R–PDSO–G8) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AA.

LAND PATTERN DATA

D (R–PDSO–G8) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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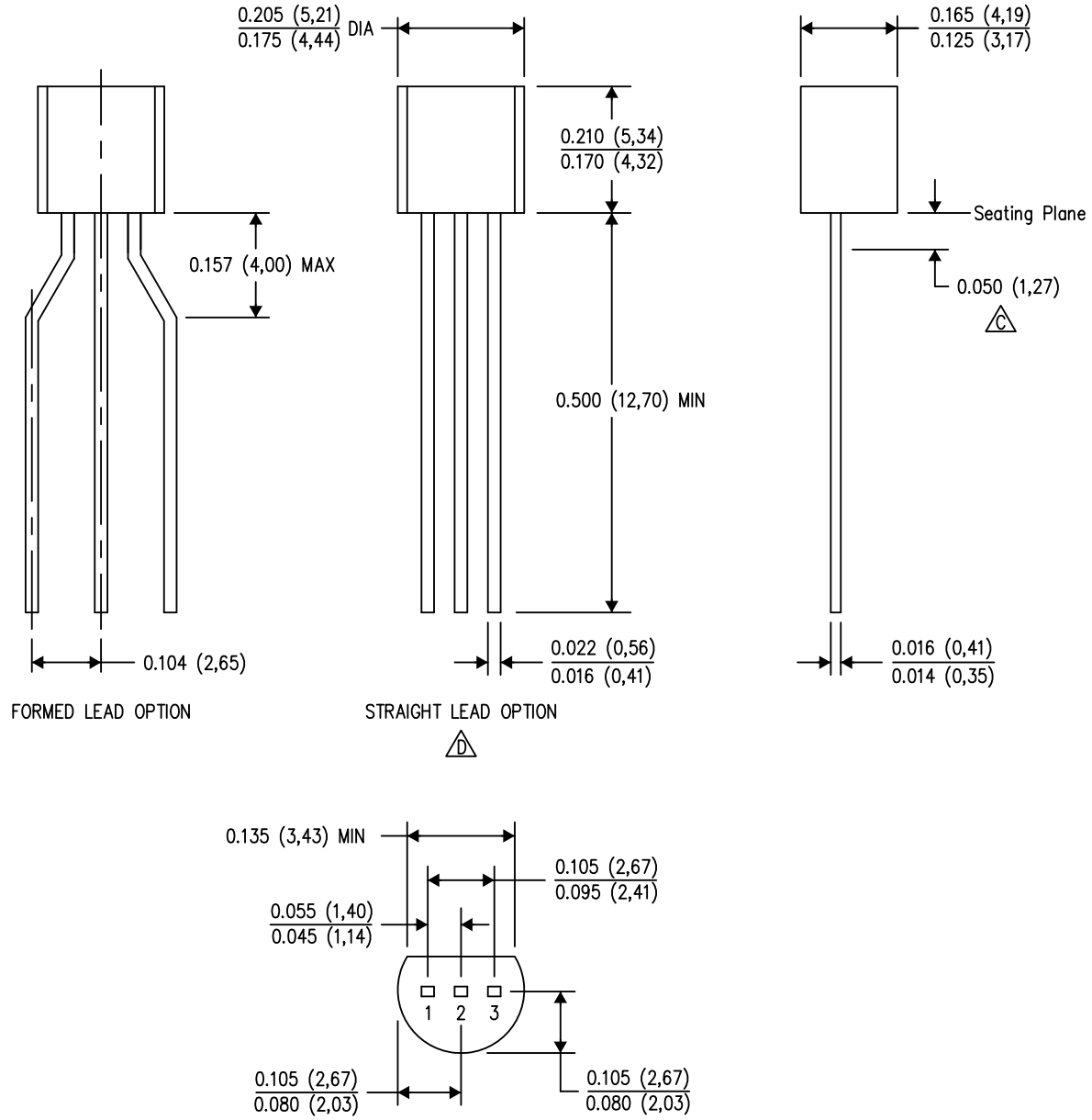
MECHANICAL DATA

LP (O–PBCY–W3) PLASTIC CYLINDRICAL PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Lead dimensions are not controlled within this area.
D. Falls within JEDEC TO–226 Variation AA (TO–226 replaces TO–92).
E. Shipping Method:
Straight lead option available in bulk pack only.
Formed lead option available in tape & reel or ammo pack.
Specific products can be offered in limited combinations of shipping mediums and lead options.
Consult product folder for more information on available options.

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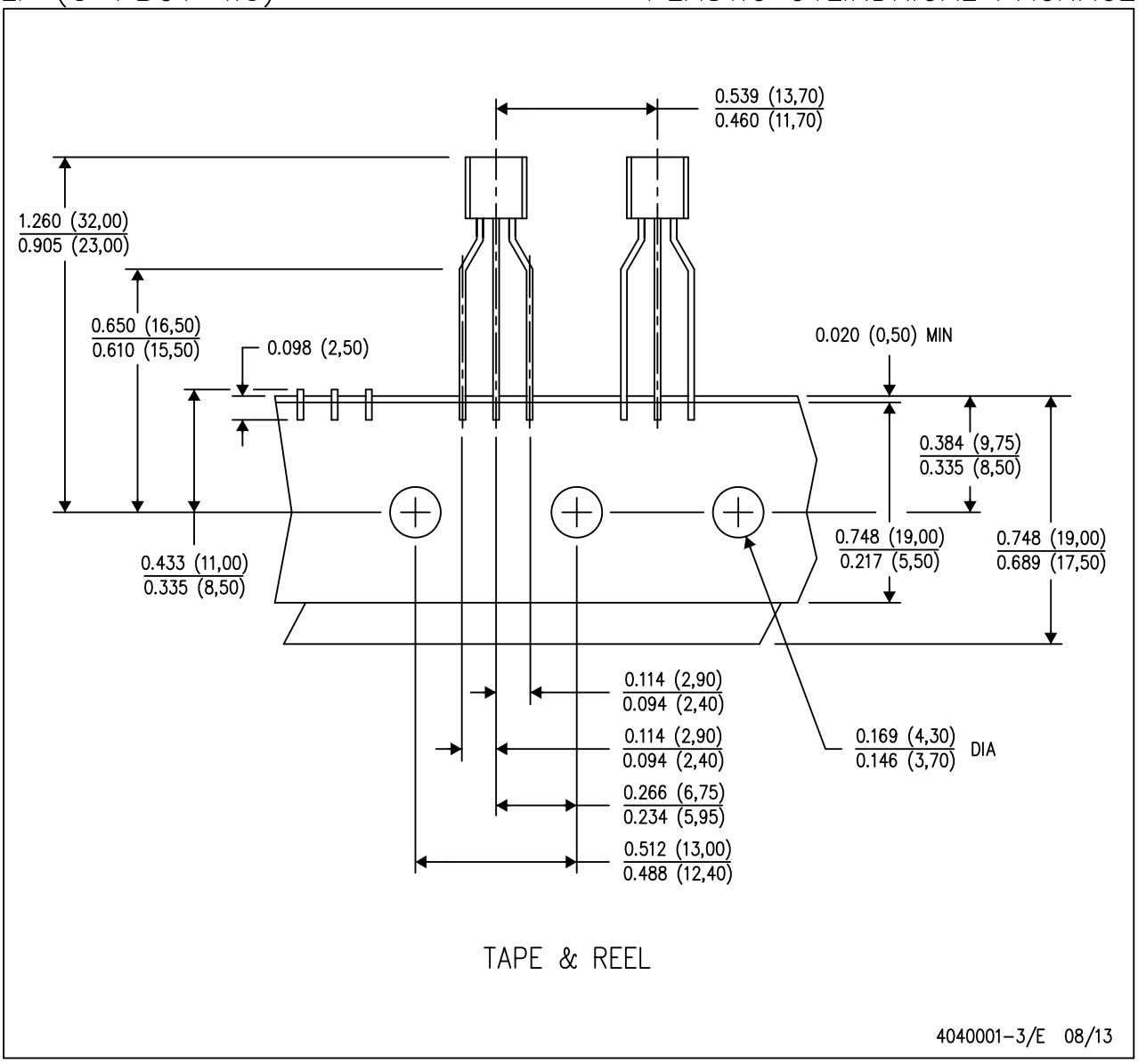
MECHANICAL DATA

LP (O–PBCY–W3) PLASTIC CYLINDRICAL PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Tape and Reel information for the Formed Lead Option package.

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